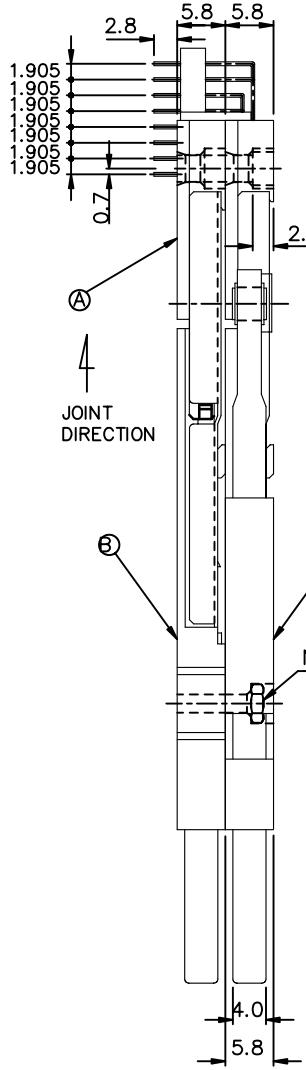


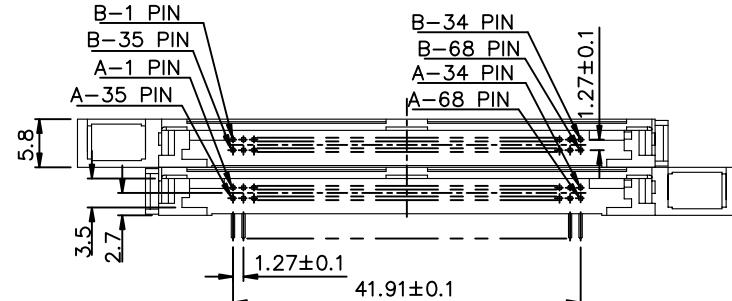
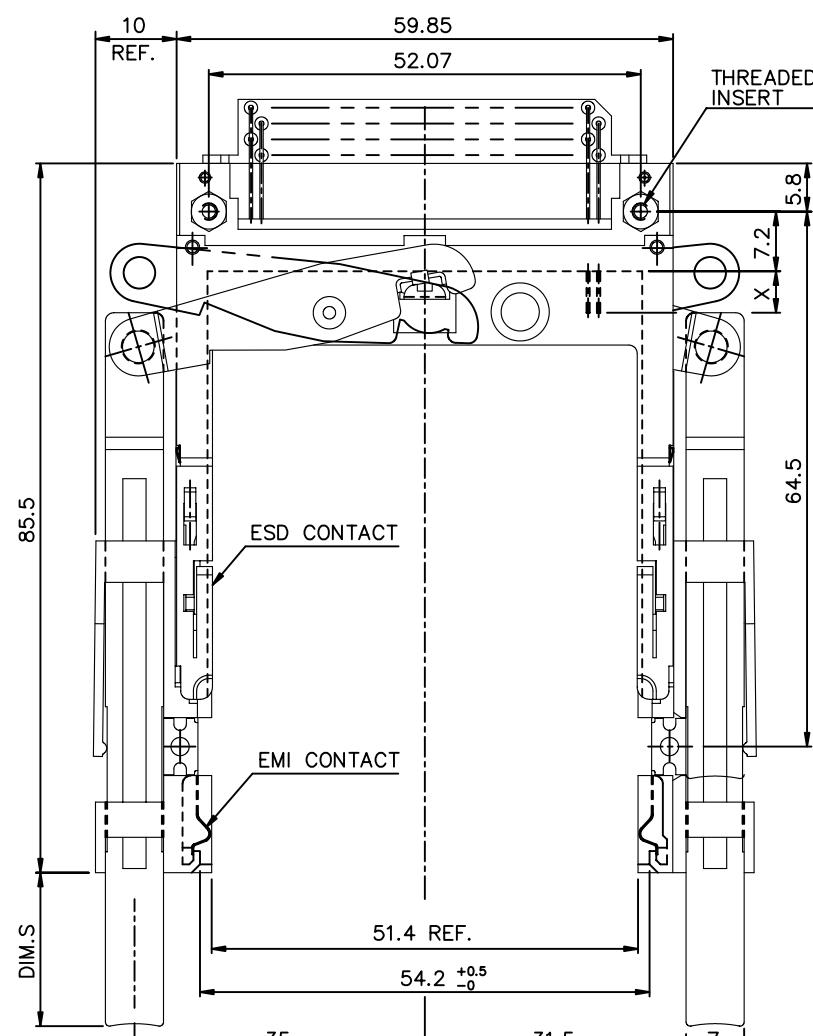
PRODUCT NO.
61150-100**/100**LF
SEE TABLE I



USE THE FOLLOWING P/N FOR OFFICIAL ORDERING

(C)	EJECT MECH ASS'Y	94307-10** SEE TABLE I
(B)	EJECT MECH ASS'Y	88644-00** SEE TABLE I
(A)	HDR ASS'Y	92821-000/000LF

D DESCRIPTION P/N



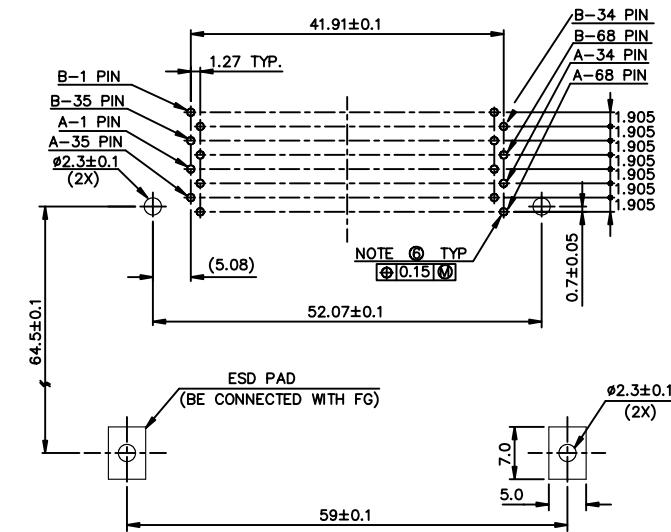
NOTES:

1. EJECT FORCE : 3.5 Kg MAX.
2. EJECT TRAVEL: 8.0mm
3. MATERIAL
 - 3.1 PART A (HEADER ASS'Y)
PLASTIC : HOUSING ...LCP UL94V-0 BLACK
:LOCATOR ...G.F. 6/6 NYLON UL94-VO BLACK
 - 3.2 PART B AND C (EJECT MECHANISM ASS'Y)
PLASTIC : GUIDE: POLYPHTHARAMID UL94V-0 BLACK
:PUSH ROD: POLYPHTHARAMID UL94V-0 BLACK
 - 3.3 PLATE : STAINLESS
 - 4. FINISH (PIN)
UNDER PLATING : 0.5µm MIN. NI
CONTACT AREA : 0.1mm MIN. GOLD OVER 0.5µm MIN. Pd-Ni
SOLDER TAIL(TIN LEAD OPTION): 2.5µm MIN. Sn-Pb
SOLDER TAIL(LEAD FREE OPTION): 2.5µm MIN. PURE TIN
 - 5. DIM "X"

4.25±0.1	3.5±0.1	5.0±0.1
OTHERS	36,67	1,17,34,35,51,68
 - 6. RECOMMENDED DIAMETER IS Ø1.0, FOR PROCESSES USING PASTE REFLOW, HOLE MAYBE AS SMALL AS Ø0.79.
 - 7. IF LEAD FREE P.N. THE HOUSING WILL WITHSTAND EXPOSURE TO 260°C PEAK TEMPERATURE FOR 10 SECONDS IN A WAVE SOLDER APPLICATION WITH A 1.00MM MINIMUM THICK CIRCUIT BOARD.
 - 8. LEAD FREE P/N PACKAGING MEETS GS-14-920 SPECIFICATION

9. TABLE I

** DIM. S	PUSH ROD COLOR
CA 13.0	BLACK
CH 13.0	NATURAL
DA 15.2	BLACK
DH 15.2	NATURAL
EA 18.5	BLACK
EH 18.5	NATURAL
FA 21.0	BLACK
FH 21.0	NATURAL



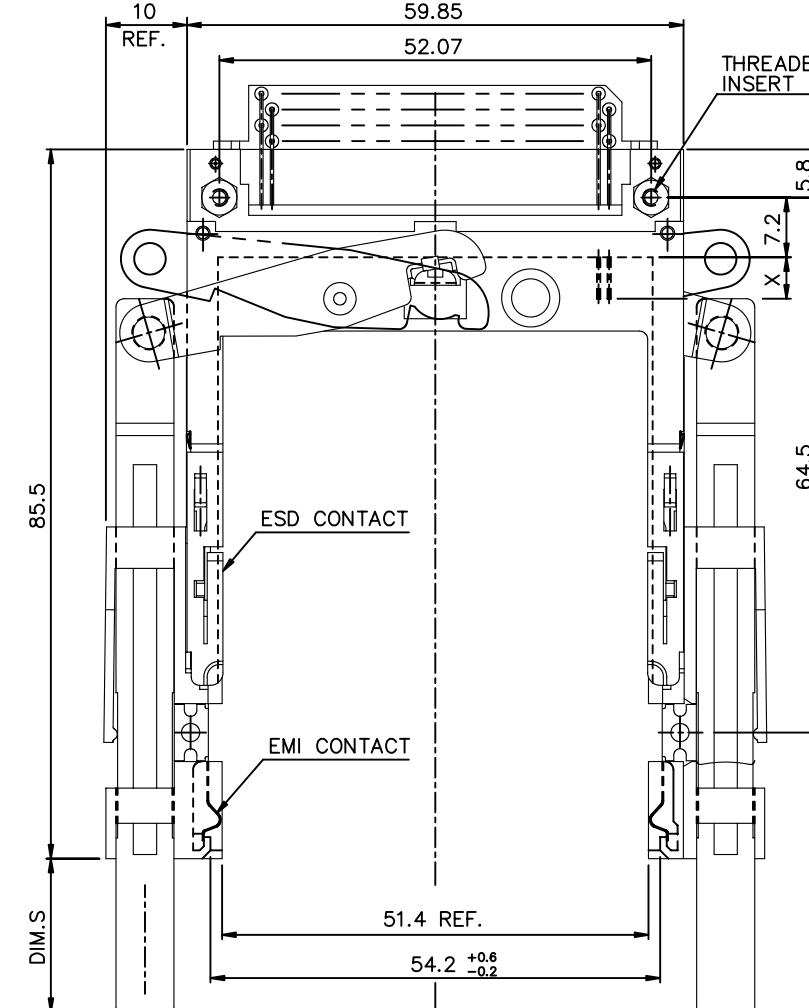
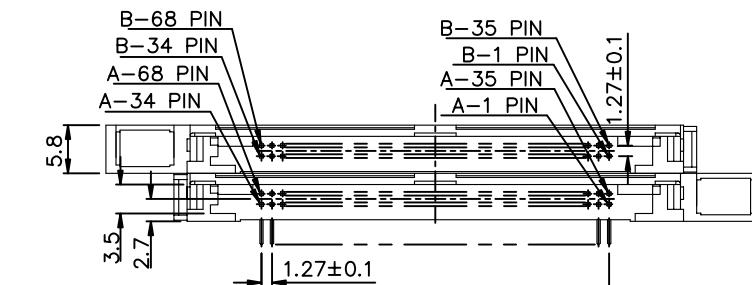
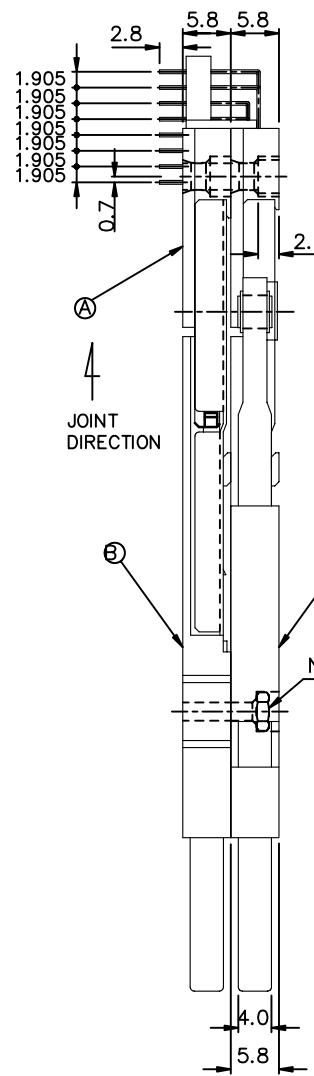
mat'l code		tolerance unless otherwise specified		CUSTOMER COPY	projection	title
rev.	ecn no.	dr	date			
D				±0.30		
				linear		
				± 2°		
				dr WENDY CHEN 09/12/96	unit mm/inch	68P DOUBLE EJECTOR HEADER ASS'Y FOR TYPE 1/2/3
				engr JOSEPH HSIA 09/12/96	scale 1.5:1	product family PCMCIA
				chr JOSEPH HSIA 09/12/96		code TWN
				appd JENN TSAO 09/12/96		size dwg no. A3
						sheet 3 OF
						Printed: Sep 28, 2007

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FCI

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PRODUCT NO.
61150-600**/600**LF
SEE TABLE I

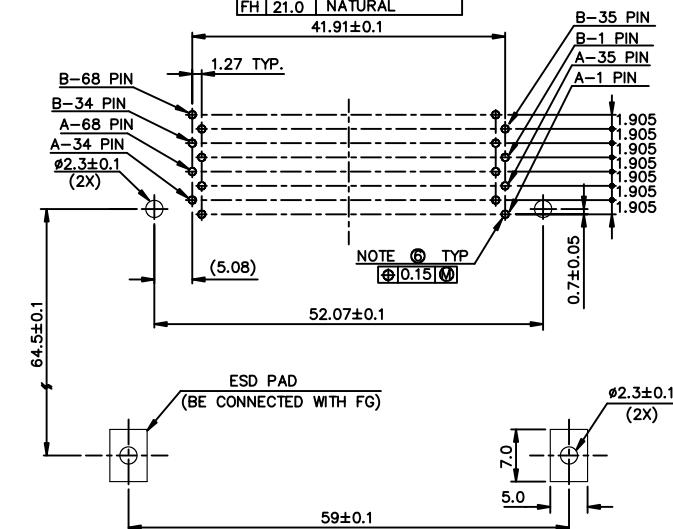


NOTES:
 1. EJECT FORCE : 3.5 Kg MAX.
 2. EJECT TRAVEL: 8.0mm
 3. MATERIAL
 3.1 PART A (HEADER ASS'Y)
 PLASTIC : HOUSING ...LCP UL94V-0 BLACK
 :LOCATOR ...G.F. 6/6 NYLON UL94-VO BLACK
 PIN : COPPER ALLOY
 3.2 PART B AND C (EJECT MECHANISM ASS'Y)
 PLASTIC : GUIDE: POLYPHTHARAMID UL94V-0 BLACK
 :PUSH ROD: POLYPHTHARAMID UL94V-0 BLACK
 PLATE : STAINLESS
 EMI CONTACT: PHOSPHOR BRONZE
 4. FINISH (PIN)
 UNDER PLATING : 0.5µm MIN. NI
 CONTACT AREA : 0.1mm MIN. GOLD OVER 0.5µm MIN. Pd-Ni
 SOLDER TAIL(TIN LEAD OPTION): 2.5µm MIN. Sn-Pb
 SOLDER TAIL(LEAD FREE OPTION): 2.5µm MIN. PURE TIN
 5. DIM "X"

4.25±0.1	3.5±0.1	5.0±0.1
OTHERS	36,67	1,17,34,35,51,68

⑥ RECOMMENDED DIAMETER IS Ø1.0, FOR PROCESSES USING PASTE REFLOW, HOLE MAYBE AS SMALL AS Ø0.79.
 7. IF LEAD FREE P.N. THE HOUSING WILL WITHSTAND EXPOSURE TO 260°C PEAK TEMPERATURE FOR 10 SECONDS IN A WAVE SOLDER APPLICATION WITH A 1.0MM MINIMUM THICK CIRCUIT BOARD.
 8. LEAD FREE P/N PACKAGING MEETS GS-14-920 SPECIFICATION

**	DIM.S	PUSH ROD COLOR
CA	13.0	BLACK
CH	13.0	NATURAL
DA	15.2	BLACK
DH	15.2	NATURAL
EA	18.5	BLACK
EH	18.5	NATURAL
FA	21.0	BLACK
FH	21.0	NATURAL

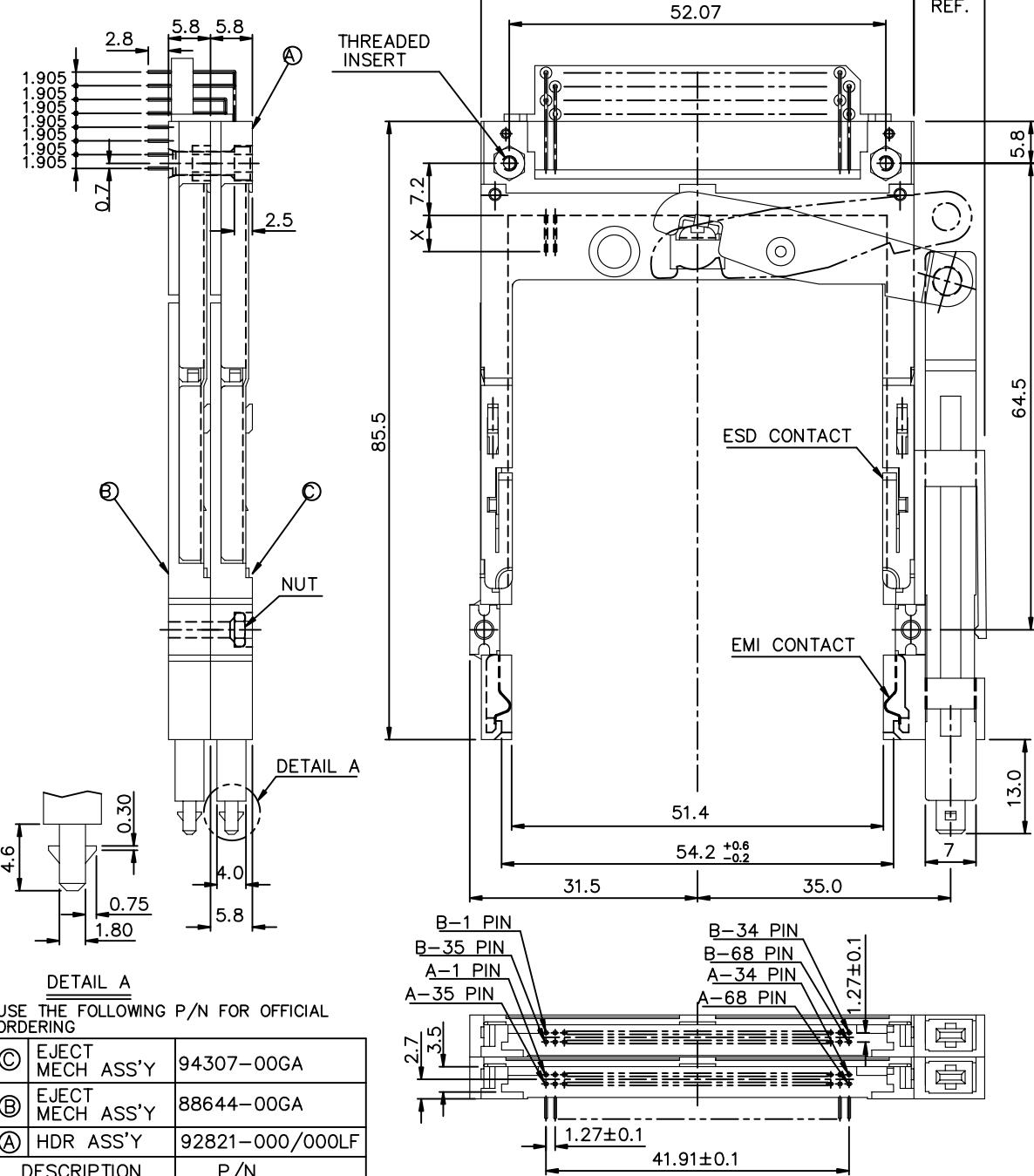


mat'l code		tolerance unless otherwise specified		CUSTOMER COPY	projection	title
rev.	ecn no.	dr	date			
G				±0.30		
				linear		
				± 2°		
				dr WENDY CHEN 12/20/00	unit mm/inch	product family : PCMCIA
				engr LEIF SHEN 12/20/00	scale 1.5:1	code TWN
				chr JOSEPH HSIA 12/20/00	dwg no. A3	size
				oppd JOSEPH HSIA 12/20/00	sheet 4 OF	sheet
						D
sheet	revision					
index	sheet					

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PRODUCT NO.

61150-200GA/200GALF



NOTES

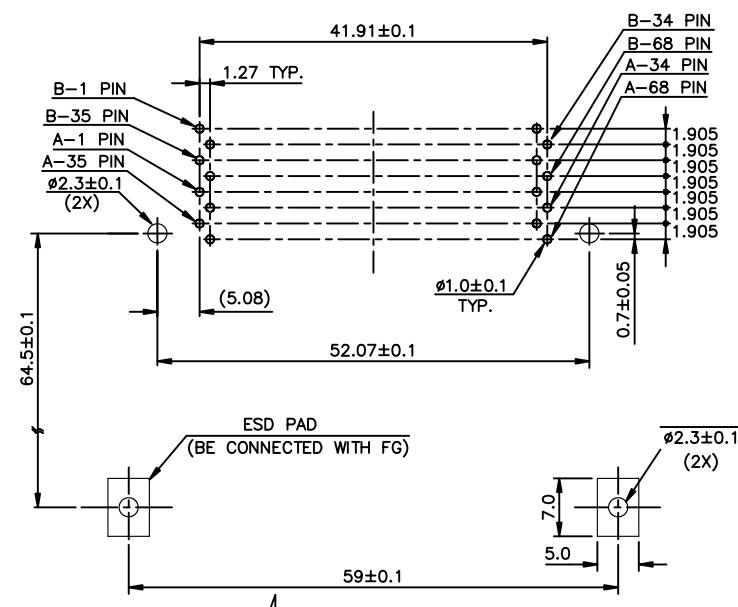
1. EJECT FORCE : 3.5 Kg MAX.
2. EJECT TRAVEL: 8.0mm
3. MATERIAL
 - 3.1 PART **(A)** (HEADER ASS'Y)

PLASTIC : HOUSING ...LCP UL94V-0 BLACK
: LOCATOR ...G.F. 6/6 NYLON UL94-VO BLACK
 - 3.2 PART **(B)** AND **(C)** (EJECT MECHANISM ASS'Y)

PLASTIC : GUIDE: POLYPHTHARAMID UL94V-0 BLACK
: PUSH ROD: POLYPHTHARAMID UL94V-0 BLACK
 - 3.3 PLATE : STAINLESS
 - 3.4 EMI CONTACT: PHOSPHOR BRONZE
4. FINISH (PIN)

UNDER PLATING : $0.5\mu\text{m}$ MIN. Ni
CONTACT AREA : $0.1\mu\text{m}$ MIN. GOLD OVER $0.5\mu\text{m}$ MIN. Pd-Ni
SOLDER TAIL(TIN LEAD OPTION): $2.5\mu\text{m}$ MIN. Sn-Pb
SOLDER TAIL(LEAD FREE OPTION): $2.5\mu\text{m}$ MIN. PURE TIN
5. DIM "X"

6. IF LEAD FREE P.N. THE HOUSING WILL WITHSTAND EXPOSURE TO 260°C PEAK TEMPERATURE FOR 10 SECONDS IN A WAVE SOLDER APPLICATION WITH A 1.00MM MINIMUM THICK CIRCUIT BOARD.
7. LEAD FREE P/N PACKAGING MEETS GS-14-920 SPECIFICATION



mat'l code				tolerance unless otherwise specified		CUSTOMER COPY	ELECTRONICS		
rev.	ecn no.	dr	date	linear	±0.30		FCI		
G					angles	±2°	projection	title	
								68P DOUBLE EJECTOR HEADER ASS'Y FOR TYPE 1/2/3	
				dr	WENDY CHEN 03/14/01	unit	product family	PCMCIA	code
				engr	MINERVA WANG 03/14/01	mm/inch	size	dwg no.	
				chr	JOSEPH HSIA 03/14/01	scale	A3	61150	sheet
				appd	JOSEPH HSIA 03/14/01	1.5:1			6 OF
sheet	revision								
index	sheet								